GaN Amplifier Pallet, 95 V, 2.3 kW
960 - 1215 MHz

MACOM PURE CARBIDE

MAPC-P1028
Rev. V2

Features

- *MACOM PURE CARBIDE*™ Amplifier Series
- Suitable for Linear & Saturated Applications
- Pulsed Operation: 2.3 kW Output Power
- Input and Output Matched to 50 Ohms
- Integrated Bias Controller/Sequencer
- 95 V Operation
- 100% RF Tested

Applications

- Avionics

Description

The MAPC-P1028 is a 50 Ohm matched high power GaN on Silicon Carbide HEMT D-mode pallet amplifier suitable for 0.960 - 1.215 GHz frequency operation. The device supports pulsed operation with output power levels of 2.3 kW (63.6 dBm).

The MAPC-P1028 uses an on board bias controller which greatly simplifies system integration. The bias controller incorporates MACOM's proprietary Power Management IC (PMIC) which features full bias sequencing, temperature compensation, on/off control, and temperature alarm. A TTL High enables the pallet while a TTL Low turns it off.

Typical Performance:

- Measured at 2.5 dB compression, 100 µs pulse width, 1% duty cycle

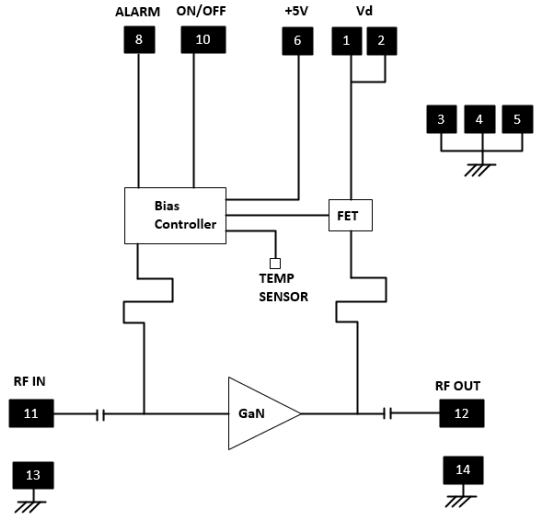
- V_{DS} = 95 V, T_C = 25°C

Frequency (GHz)	Output Power (dBm)	Gain (dB)	η_D (%)
0.960	65.5	17.1	48.7
1.100	64.8	16.5	45.4
1.215	64.4	17.7	50.1

Ordering Information

Part Number	Configuration
MAPC-P1028-AB000	Microstrip RF Launch
MAPC-P1028-ABSB1	SMA Connectorized

Functional Schematic



DC/Controller Pin Configuration

Pin #	Pin Name	Function
1, 2	V_D	Drain Voltage
3, 4, 5	GND	Ground
6	5 V	Controller Supply
8	Alarm	Alarm Output
10	On/Off	Pallet Enable/ Blank

RF Interface

Pin #	Pin Name	Function
11	RF_{IN}	RF Input
12	RF_{OUT}	RF Output
13, 14	GND	Ground

RF Electrical Characteristics: T_C = 25°C, V_{DS} = 95 V
Note: Performance in MACOM Evaluation Test Fixture, 50 Ω system

Parameter	Test Conditions	Symbol	Min.	Typ.	Max.	Units
Power Gain	Pulsed[1], 2.5dB Gain Compression, 0.960 GHz Pulsed[1], 2.5dB Gain Compression, 1.100 GHz Pulsed[1], 2.5dB Gain Compression, 1.215 GHz	G_{SAT}	— — —	17.1 16.5 17.7	— — —	dB
Saturated Drain Efficiency	Pulsed[1], 2.5dB Gain Compression, 0.960 GHz Pulsed[1], 2.5dB Gain Compression, 1.100 GHz Pulsed[1], 2.5dB Gain Compression, 1.215 GHz	η_{SAT}	— — —	48.7 45.4 50.1	— — —	%
Saturated Output Power	Pulsed[1], 2.5dB Gain Compression, 0.960 GHz Pulsed[1], 2.5dB Gain Compression, 1.100 GHz Pulsed[1], 2.5dB Gain Compression, 1.215 GHz	P_{SAT}	— — —	65.5 64.8 64.4	— — —	dBm
Power Gain	Pulsed[1], P_{OUT} = 63.6 dBm, 0.960 GHz Pulsed[1], P_{OUT} = 63.6 dBm, 1.100 GHz Pulsed[1], P_{OUT} = 63.6 dBm, 1.215 GHz	G_P	— — —	19.5 18.6 19.2	— — —	dB
Drain Efficiency	Pulsed[1], P_{OUT} = 63.6 dBm, 0.960 GHz Pulsed[1], P_{OUT} = 63.6 dBm, 1.100 GHz Pulsed[1], P_{OUT} = 63.6 dBm, 1.215 GHz	η	— — —	40.2 40.7 47.3	— — —	%
Input Return Loss	Small signal, 0.960 GHz Small signal, 1.100 GHz Small signal, 1.215 GHz	IRL	— — —	- 10.6 - 5.9 - 10.3	— — —	dB
Gain Flatness	Pulsed[1], P_{OUT} = 63.6 dBm, 0.960 - 1.215 GHz	ΔG	—	+/- 1.5	—	dB
Phase Variation	Pulsed[1], P_{OUT} = 63.6 dBm, 0.960 - 1.215 GHz	$\Delta\phi$	—	+/- 15	—	Deg
Ruggedness: Output Mismatch	All phase angles	Ψ	VSWR = TBD, No Damage			

RF Electrical Specifications: T_A = 25°C, V_{DS} = 95 V
Note: Performance in MACOM Production Test Fixture, 50 Ω system

Parameter	Test Conditions	Symbol	Min.	Typ.	Max.	Units
Power Gain	Pulsed[1], 2.5dB Gain Compression, 0.960 GHz Pulsed[1], 2.5dB Gain Compression, 1.100 GHz Pulsed[1], 2.5dB Gain Compression, 1.215 GHz	G_P	— — —	15.5 15.5 15.5	— — —	dB
Gain Flatness	Pulsed[1], P_{OUT} = 63.6 dBm, 0.960 - 1.215 GHz	ΔG	—	+/- 1.5	—	dB
Drain Efficiency	Pulsed[1], 2.5dB Gain Compression, 0.960 GHz Pulsed[1], 2.5dB Gain Compression, 1.100 GHz Pulsed[1], 2.5dB Gain Compression, 1.215 GHz	η	— — —	46.5 43.0 46.5	— — —	%
Input Return Loss	Small signal, 0.960 GHz Small signal, 1.100 GHz Small signal, 1.215 GHz	IRL	— — —	- 10.6 - 5.9 - 10.3	— — —	dB

1. Pulse details: 100 µs pulse width, 1% duty cycle.

Absolute Maximum Ratings[2,3,4,5,6]

Parameter	Absolute Maximum
Output Power, P_{OUT}	66 dBm
Drain Source Voltage, V_{DS}	98 V
Storage Temperature Range	-40°C to +150°C
Case Operating Temperature Range	-40°C to +85°C
Channel Operating Temperature Range, T_{CH}	-40°C to +225°C
Absolute Maximum Channel Temperature	+250°C

2. Exceeding any one or combination of these limits may cause permanent damage to this device.
3. MACOM does not recommend sustained operation above maximum operating conditions.
4. Operating at drain source voltage $V_{DS} \leq 150$ V will ensure MTTF > 2 x 10^6 hours.
5. Operating at nominal conditions with $T_{CH} \leq 225$°C will ensure MTTF > 2 x 10^6 hours.
6. MTTF may be estimated by the expression MTTF (hours) = A $e^{[B + C/(T+273)]}$ where T is the channel temperature in degrees Celsius, A = 1, B = -38.215, and C = 26,343.

RF Device Thermal Characteristics[7]

Parameter	Test Conditions	Symbol	Typical	Units
Thermal Resistance using Finite Element Analysis (Pulsed : 100 us, 1%)	V_{DS} = 95 V, T_C = 85°C, T_{CH} = 225°C	R_{θ}(FEA)	0.034	°C/W
Thermal Resistance using Infrared Measurement of Die Surface Temperature	V_{DS} = 95 V, T_C = 85°C, T_{CH} = 225°C	R_{θ}(IR)	0.029	°C/W

7. Temperature is measured under the pallet. Contact local applications support team for more details on this measurement.

Handling Procedures

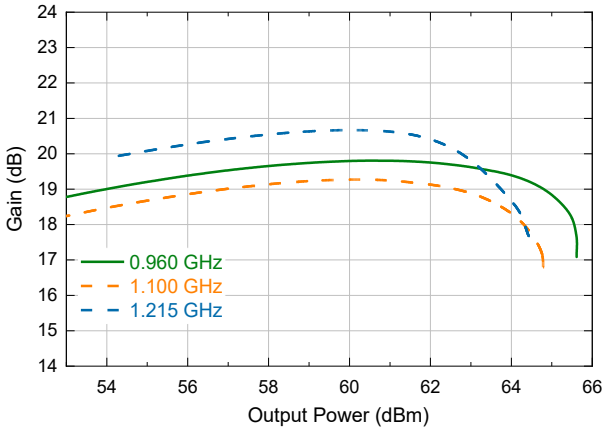
Please observe the following precautions to avoid damage:

Static Sensitivity

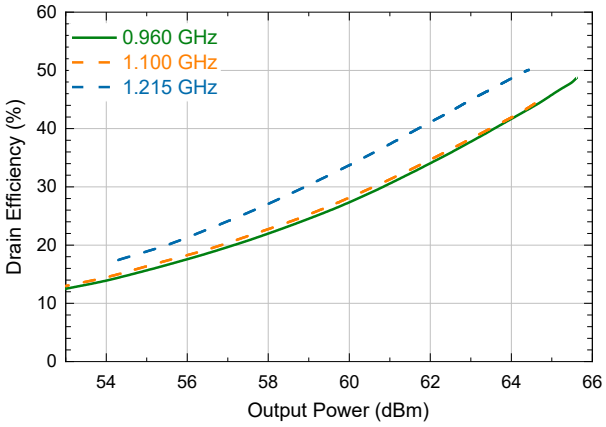
Gallium Nitride Circuits are sensitive to electrostatic discharge (ESD) and can be damaged by static electricity. Proper ESD control techniques should be used when handling these devices.

Typical Performance Curves: Pulsed[1], V_{DS} = 95 V, I_{DQ} = 230 mA, T_C = 25°C

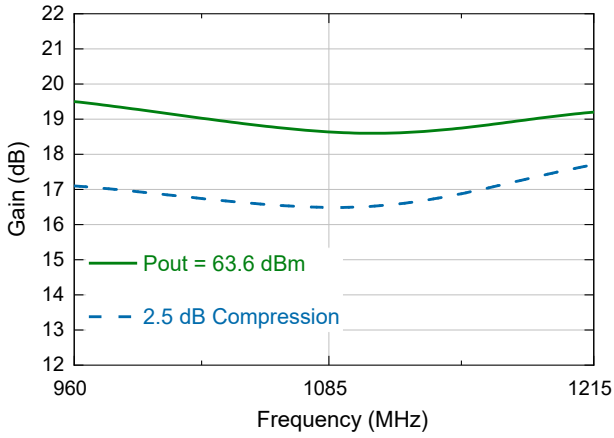
Gain vs. Output Power and Frequency



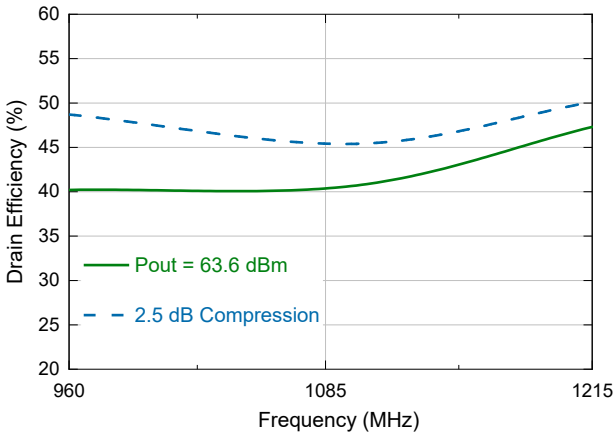
Drain Efficiency vs. Output Power and Frequency



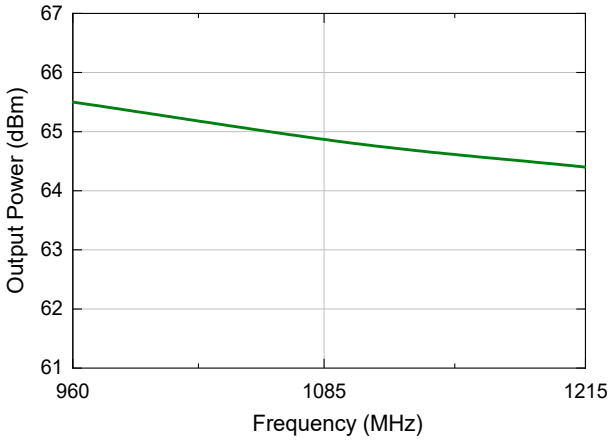
Gain vs. Frequency



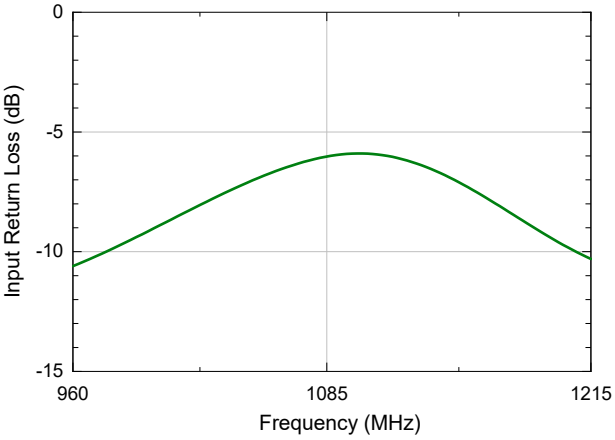
Drain Efficiency vs. Frequency



Output Power vs. Frequency, 2.5dB Compression



IRL vs. Frequency



Outline Drawing: (unit : inch [mm])